



Innovative Tile and Stone
Installation Systems

AIA-28

Leveling and Surface Preparation for Flooring Products

Provider: LATICRETE International, Inc. (J-037)

Program: Leveling and Surface Preparation for Flooring Products

Program #: AIA-28

Credits: 1 LU Hour

HSW: Yes

Description:

The first thing we will cover in this presentation is the substrate, and how to determine whether it is suitable and how to prepare this substrate for subsequent installations. From there on we will go over how to determine which mud bed would be suitable, a bonded or un-bonded application. We will also cover when it is appropriate to use a self-leveling underlayment, how to use them and how to prepare your substrate for its installation. Finally, we will cover patching and skimming and when to use these products.

Learning Objectives:

At the end of the program, the participant will be able to:

1. Identify contamination and proper preparation.
2. Learn about thick bed mortars: bonded and unbonded.
3. Learn about Self Leveling Underlayments – problem substrates, estimation, and installation.
4. Learn about patching/skimming uses.

Approach:

A PowerPoint presentation that incorporates photo images, project installations and computer animation will be used. There will be a questions and answer period at the end of the program, however, the program is designed to be interactive, and questions are encouraged throughout as well.

A/V Needed:

Electric power and a screen, video system or blank wall for the PowerPoint presentation. (The CES facilitator will provide the laptop and projector).

Target Audience:

Architects, Engineers, Specifiers, Owners, and other Design Professionals in the commercial, residential, and industrial markets.

Facilitator Qualifications:

The CES facilitators receive in-house training on CES guidelines and presentation skills. All have extensive construction industry experience and up to 25 years in the tile and stone industry.

Cost:

Not Applicable. There is no fee for bringing this program into a firm or chapter meeting.